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Substitute for form 1449B/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT Date Submitted: November 20, 2003 (use as many sheets as necessary)		Complete If Known Application Number: <u>Unassigned 10/716 600</u> Filing Date: <u>11/20/2003</u> First Named Inventor: <u>Colin WILSON</u> Group Art Unit: <u>2819-2879</u> Examiner Name: <u>Unassigned Williams</u> Attorney Docket Number: <u>040849-0254</u>	
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U.S. PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number	Kind Code ² (if known)			
<i>AW</i>	A1	6,232,705		FORBES et al.	05/15/2001	
<i>AW</i>	A2	6,148,061		SHEFER et al.	11/14/2000	
<i>AW</i>	A3	6,008,064		BUSTA	12/28/1999	
<i>AW</i>	A4	6,007,396		WILLIAMS	12/28/1999	
<i>AW</i>	A5	5,969,473		HUANG et al.	10/19/1999	
<i>AW</i>	A6	5,939,833		SONG et al.	08/17/1999	
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<i>AW</i>	A11	5,828,288		JONES et al.	10/27/1998	
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FOREIGN PATENT DOCUMENTS								
Examiner Initials*	Cite No. ¹	Foreign Patent Document			Name of Patentee or Applicant of Cited Documents	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶
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OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ⁶

Examiner Signature	<i>Joseph Williams</i>	Date Considered	7/20/04
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¹ Unique citation designation number. ² See attached Kinds of U.S. Patent Documents. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document.

⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

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